



## Material Declaration Data Sheet

Product: **Server Chassis SR2520/Server System SR2520SA Refresh** Manufacturer: Intel Corp

Date: September 28, 2007

### Notes:

*This declaration applies to all associated product codes noted on following pages*

*This product and its associated spares and accessories noted on following pages comply with the EU RoHS Directive 2002/95/EC.*

## Restriction on Hazardous Substances (RoHS) Compliance

### RoHS Definition

- Quantity limit of 0.1% by mass (1000PPM) for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE)
- Quantity limit of 0.01% by mass (100 PPM) for: Cadmium

Intel understands RoHS requires: Lead and other materials banned in the RoHS Directive are either (1) below all applicable substance thresholds as proposed by the EU or (2) an approved/pending exemption applies. (Note: RoHS implementing details are not fully defined and may change.)

### RoHS Declaration

- 1. Lead in glass of cathode ray tubes, electronic components and fluorescent tubes.
- 2. Lead as an alloying element in steel containing up to 0.35 % lead by weight.
- 3. Lead as an alloying element in aluminum containing up to 0.4 % lead by weight.
- 4. Lead as an alloying element in copper containing up to 4 % lead by weight.
- 5. Lead in high melting temperature type solders (i.e. lead based alloys containing 85 % by weight or more lead)
- 6. Lead in solders for servers, storage and storage array systems, network infrastructure equipment for switching, signaling, transmission as well as network management for telecommunications.
- 7. Lead in electronic ceramic parts (e.g. piezoelectronic devices).
- 8. Lead used in compliant pin connector systems.
- 9. Lead as a coating material for the thermal conduction module c-ring.
- 10. Lead in optical and filter glass.
- 11. Lead in solders consisting of more than two parts for the connection between the pins and the package of microprocessors with a lead content of more than 80% and less than 85% by weight.
- 12. Lead in solders to complete a viable electrical connection between semiconductor die and carrier within integrated circuit Flip Chip packages.
- 13. Cadmium in optical and filter glass.
- 14. Cadmium and its compounds in electrical contacts and cadmium plating except for applications banned under Directive 91/338/EEC (\*) amending Directive 76/769/EEC (\*\*) relating to restrictions on the marketing and use of certain dangerous substances and preparations.
- 15. Lead in bronze bearing shells and brushes.
- 16. Other

Where the product is declared to meet RoHS requirements, it has been verified to be in conformance with 2002/95/EC as we currently understand the requirements. Intel has systems in place to verify conformance with all applicable environmental requirements and to the best of our knowledge the information is true and correct.

INTEL ACCEPTS NO DUTY TO UPDATE THIS DECLARATION OR TO NOTIFY USERS OF THIS DECLARATION OF UPDATES OR CHANGES TO THIS DECLARATION. INTEL SHALL NOT BE LIABLE FOR ANY DAMAGES, DIRECT OR INDIRECT, CONSEQUENTIAL OR OTHERWISE, SUFFERED BY USERS OR THIRD PARTIES AS A RESULT OF THE USERS RELIANCE ON INFORMATION IN THIS DECLARATION THAT HAS BEEN UPDATED OR CHANGED.

# Product Code Information



\* RoHS Exemption # corresponds with exemption #'s found on page 1.

Product Code	Description	*RoHS Exemption #
SR2520SAFR	Integrated system with 4-DIMM SATA MOBO, fixed 3.5" SATA drive chassis, Refresh	2, 6
SR2520SAFRNA	Integrated system with 4-DIMM SATA MOBO, fixed 3.5" SATA drive chassis, North-America power-cord included, Refresh	2, 6
SR2520SAXR	Integrated system with 8-DIMM SATA MOBO, non-expander (passive) backplane, and 3.5" hot-swap SATA drive chassis, refresh	2, 6
SR2520SAXRNA	Integrated system with 8-DIMM SATA MOBO, non-expander (passive) backplane, 3.5" hot-swap SATA drive chassis, NA power-cord included, refresh	2, 6
SR2520SAXSR	Integrated system with 8-DIMM SAS MOBO, expander (active) backplane, and 3.5" hot-swap SATA drive support chassis, refresh	2, 6
SR2520SAXSRNA	Integrated system with 8-DIMM SAS MOBO, expander (active) backplane, 3.5" hot-swap SATA drive support chassis, NA power-cord included, refresh	2, 6
FOWSPRKIT	Mechanical spares kit	2, 6
AOWFANKIT	Spare fan kit containing two (2) fans	2, 6
FSR2520PDB	Spare power distribution board	2, 6
FSR600WFPS	SR2520 spare 600W Fixed Power Supply	2, 6